



5A SCHOTTKY BARRIER RECTIFIER POWERDI®

Features

- Guard Ring Die Construction for Transient Protection
- High Surge Current Capability
- Low Leakage Current
- Low Power Loss, High Efficiency
- For Use in High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- High Forward Surge Current Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

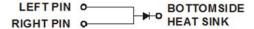
- Case: POWERDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Polarity: See Diagram
- Weight: 0.094 grams (Approximate)

POWERDI®5



Top View

Bottom View



Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

Part Number	Case	Packaging
PDS560-13	POWERDI [®] 5	5,000/Tape & Reel
PDS560Q-13	POWERDI [®] 5	5 000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



S560 = Product Type Marking Code

O|| = Manufacturers' Code Marking

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 15 for 2015)

WW = Week Code (01 – 53)

K = Factory Designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
RMS Reverse Voltage	$V_{R(RMS)}$	42	V
Average Rectified Output Current	lo	5	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	150	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{ heta}$ JS	_	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) $T_A = +25$ °C	$R_{ heta JA}$	95	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6) T _A = +25°C	$R_{ heta JA}$	70	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 7) T _A = +25°C	$R_{ heta JA}$	50	_	°C/W
Operating and Storage Temperature Range	T _J , T _{STG} -65 to +150		+150	°C

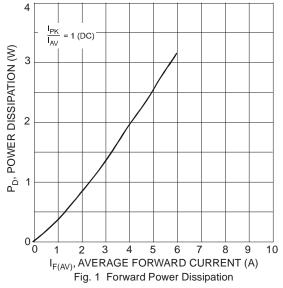
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

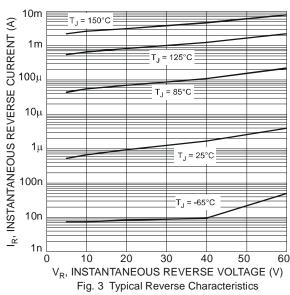
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	60	_	_	V	$I_R = 0.2 \text{mA}$
		_	0.61	0.67	V	$I_F = 5A, T_S = +25^{\circ}C$
Forward Voltage	VF		0.54	0.60		I _F = 5A, T _S = +125°C
I orward voltage	VF		0.71	0.77		$I_F = 8A, T_S = +25^{\circ}C$
		_		0.68		$I_F = 8A, T_S = +125$ °C
		_	4	150	μΑ	$T_S = +25^{\circ}C, V_R = 60V$
Reverse Leakage Current (Note 8)	I _R	_	_	15	mΑ	$T_S = +100$ °C, $V_R = 60$ V
		_	2	30	mA	$T_S = +125$ °C, $V_R = 60$ V

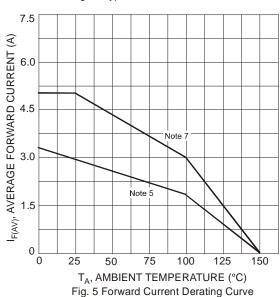
Notes:

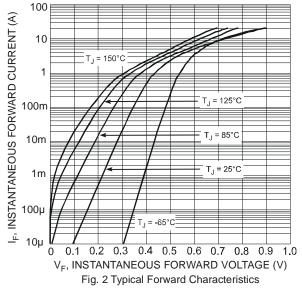
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
 Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
 Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 Short duration pulse test used to minimize self-heating effect.

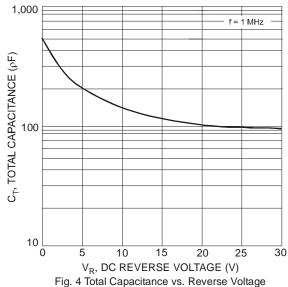












200 Note 5

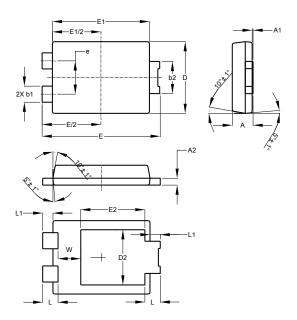
No

Fig. 6 Operating Temperature Derating



Package Outline Dimensions

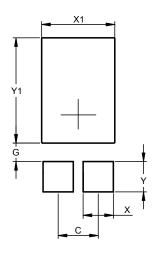
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI [®] 5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A1	0.00	0.05			
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2			3.054		
Е	6.40	6.60	6.504		
е			1.84		
E1	5.30	5.45	5.37		
E2			3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860



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